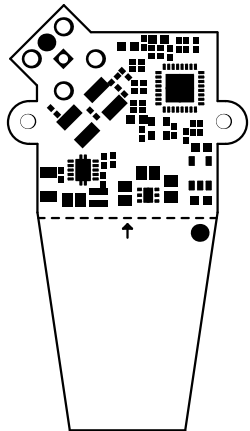
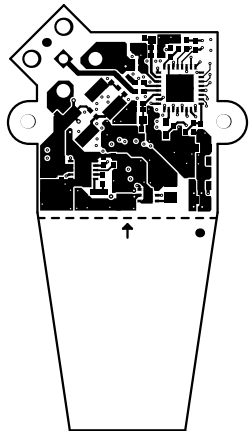


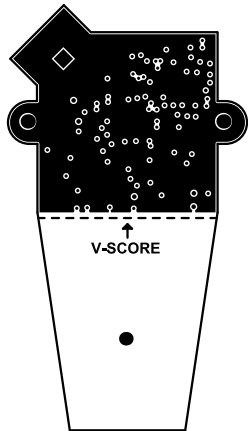
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 2/28/2018 11:52:00 AM	TEXAS INSTRUMENTS	



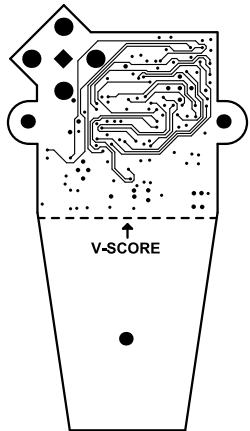
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 2/28/2018 11:52:03 AM	TEXAS INSTRUMENTS	



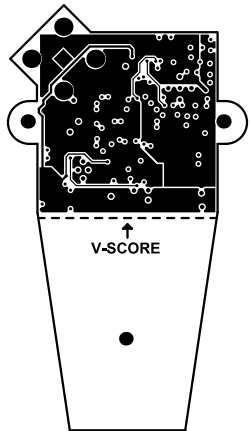
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 2/28/2018 11:52:07 AM	TEXAS INSTRUMENTS	



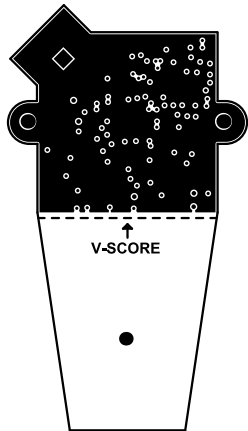
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Board-Outline Micro-Outline	TID #: N/A		
PLOT NAME = Ground Layer 2	GENERATED : 2/28/2018 11:52:11 AM	TEXAS INSTRUMENTS	



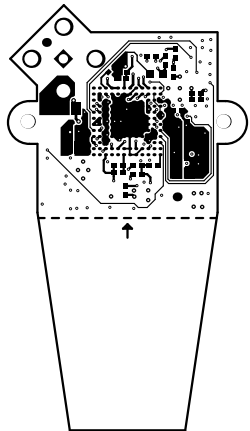
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = MyBoard-Original Video, Control Layer 3	TID #: N/A		
PLOT NAME = Video, Control Layer 3	GENERATED : 2/28/2018 11:52:15 AM	TEXAS INSTRUMENTS	



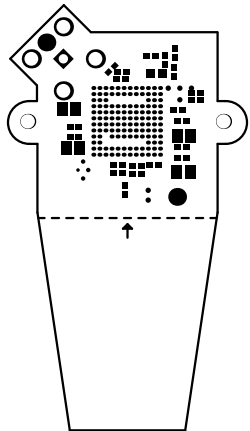
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Main Board-001.cbr Main Board-001.cbr	TID #: N/A		
PLOT NAME = Power Layer 4	GENERATED : 2/28/2018 11:52:18 AM		TEXAS INSTRUMENTS



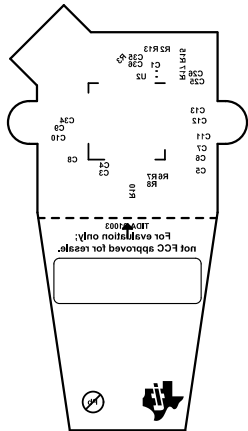
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Micro 2 GND Layer 5	TID #: N/A		
PLOT NAME = Ground Layer 5	GENERATED : 2/28/2018 11:52:22 AM	TEXAS INSTRUMENTS	



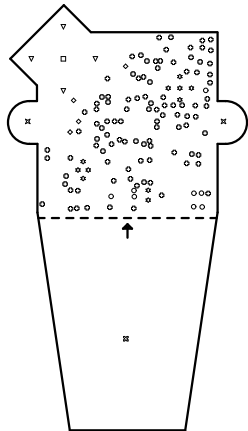
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Layer 6 - Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 2/28/2018 11:52:26 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 2/28/2018 11:52:30 AM	TEXAS INSTRUMENTS	

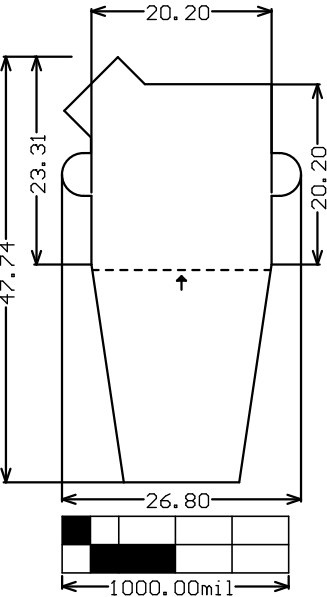


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 2/28/2018 11:52:34 AM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⌘	2	62.99mil (1.600mm)	NPTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
⊗	1	280.00mil (7.112mm)	NPTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
⊗	102	6.00mil (0.152mm)	PTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
⊗	11	7.87mil (0.200mm)	PTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
○	8	8.00mil (0.203mm)	PTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
◇	4	10.00mil (0.254mm)	PTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
□	1	41.34mil (1.050mm)	PTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
▽	4	61.02mil (1.550mm)	PTH	Round	Layer 1 - Top Layer - Layer 6 - Bottom Layer	
133 Total						

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 2/28/2018 11:52:37 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01003	REV: E4	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 2/28/2018 11:52:43 AM	TEXAS INSTRUMENTS	

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